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U.S. UTILITY Patent Application

APPL NUM 10017350	FILING DATE 12/14/2001	CLASS 228	SUBCLASS	GAU 1725	EXAMINER Stoner				
**APPLICANT	S: Rinne (Slenn; Na	ir Krishna;						
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TITLE : Low te	mperature method	s of bond	ing componen	ts and re	lated structures U.S.DEPT. OF COMM./PAT.& TH	1-PTO-436L(Rev. 12-			
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TERMINAL	PREPARED FOR ISSUE	Application Examiner
DISCLAMER	WARNING: The information disclose Unauthorized disclosure may be prohibi Sections 122, 181 and 368, Possession of Office is restricted to authorized employ	ted by the United States Code Title 35, auxide the U.S. Patent & Trademark
	FILED WITH: DISK	(CRE) (Attached in poctet on right have step)